

**TOSHIBA CORPORATION**

Toshiba Electronic Devices &amp; Storage Corporation

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Date: Nov. 9, 2022

Ref. No.: DO2022-00067E-H01

Dear Sir/ Madam:

**Notification of New Materials for Desiccant**

We greatly appreciate your continued business.

This is to notify our customers of our plan to change wafer fab of our products supplied to you.

Full details of the planned change are given in the following page.

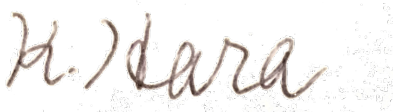
If you have any questions or inquiry regarding this change, please inform our Sales representatives nearest you as soon as possible.

We appreciate your understanding and cooperation.

Yours faithfully,

Reviewed by H. Kashima

Approved by K.Hara, Manager



Toshiba Electronic Devices & Storage Corporation

Semiconductor quality & reliability engineering department(dept.)

Quality & Reliability group I ,Oita Office

**Notification of New Materials for Desiccant**

1. Product to be Affected : See Attachment
2. Description of Change : - This is to inform the customer of the switch to the new material of the drying agent
3. Reason of Change : To ensure a stable supply, we will switch from the silica gel desiccant currently used to the bentonite desiccant..
4. Scheduled Date of Change : From December 2022
5. Remark : If you have any questions or requests regarding this change, please inform our Sales representatives nearest you as soon as possible.